IGBT - Field Stop II

This Insulated Gate Bipolar Transistor (IGBT) features a robust and cost effective Field Stop II Trench construction, and provides superior performance in demanding switching applications, offering both low on state voltage and minimal switching loss. The IGBT is well suited for UPS and solar applications. Incorporated into the device is a soft and fast co–packaged free wheeling diode with a low forward voltage.

Features

- Extremely Efficient Trench with Field Stop Technology
- $T_{Jmax} = 175^{\circ}C$
- Soft Fast Reverse Recovery Diode
- Optimized for High Speed Switching
- 10 µs Short Circuit Capability
- These are Pb–Free Devices

Typical Applications

- Solar Inverter
- Uninterruptible Power Inverter Supplies (UPS)
- Welding

ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Collector-emitter voltage	V _{CES}	1200	V
Collector current @ Tc = 25°C @ Tc = 100°C	Ic	50 25	A
Pulsed collector current, T _{pulse} limited by T _{Jmax}	Ісм	100	A
Diode forward current @ Tc = 25°C @ Tc = 100°C	I _F	50 25	A
Diode pulsed current, T_{pulse} limited by T_{Jmax}	I _{FM}	100	A
Gate-emitter voltage Transient gate-emitter voltage ($T_{pulse} = 5 \ \mu s, D < 0.10$)	V _{GE}	±20 ±30	V
Power Dissipation @ Tc = 25°C @ Tc = 100°C	PD	385 192	W
Short Circuit Withstand Time V_{GE} = 15 V, V_{CE} = 500 V, T_J \leq 150°C	T _{SC}	10	μS
Operating junction temperature range	ТJ	–55 to +175	°C
Storage temperature range	T _{stg} –55 to +175		°C
Lead temperature for soldering, 1/8" from case for 5 seconds	T _{SLD} 260		°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.



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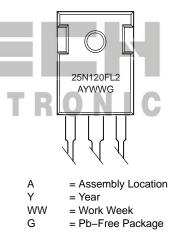
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25 A, 1200 V V_{CEsat} = 2.0 V E_{off} = 0.60 mJ



MARKING DIAGRAM

GGG



ORDERING INFORMATION

Device	Package	Shipping
NGTB25N120FL2WG	TO–247 (Pb–Free)	30 Units / Rail

1 Publication Order Number: Published by WWW.SKYTECH.I

THERMAL CHARACTERISTICS

Rating	Symbol	Value	Unit
Thermal resistance junction-to-case, for IGBT	$R_{ extsf{ heta}JC}$	0.39	°C/W
Thermal resistance junction-to-case, for Diode	$R_{ extsf{ heta}JC}$	0.63	°C/W
Thermal resistance junction-to-ambient	R_{\thetaJA}	40	°C/W

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise specified)

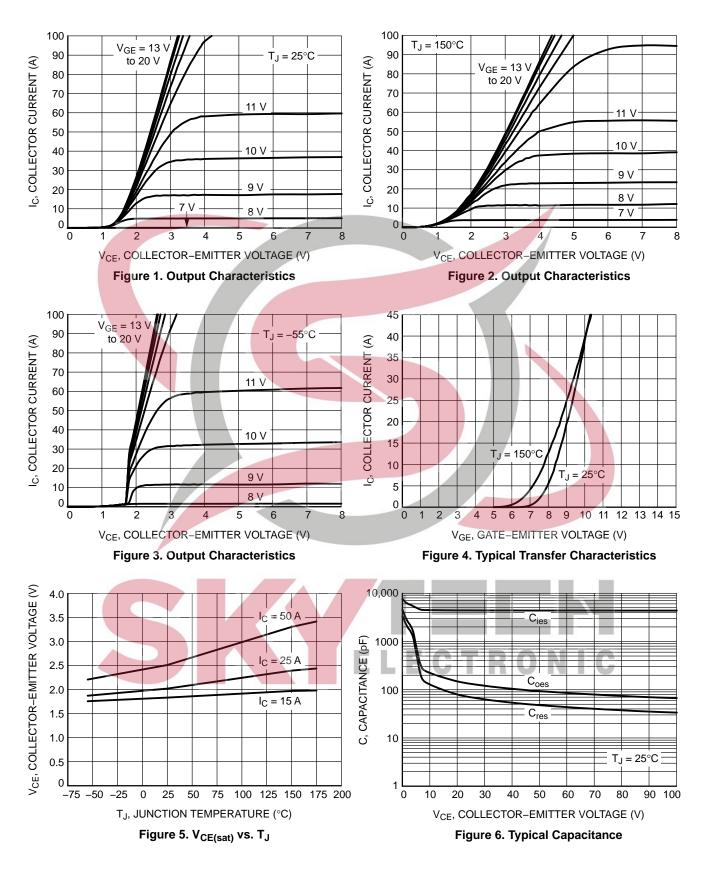
Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
STATIC CHARACTERISTIC						
Collector–emitter breakdown voltage, gate–emitter short–circuited	$V_{GE} = 0 \text{ V}, I_{C} = 500 \mu\text{A}$	V _{(BR)CES}	1200	-	_	V
Collector-emitter saturation voltage	$V_{GE} = 15 \text{ V}, I_C = 25 \text{ A}$ $V_{GE} = 15 \text{ V}, I_C = 25 \text{ A}, T_J = 175^{\circ}\text{C}$	V _{CEsat}		2.00 2.40	2.40	V
Gate-emitter threshold voltage	$V_{GE} = V_{CE}, I_C = 400 \ \mu A$	V _{GE(th)}	4.5	5.5	6.5	V
Collector–emit <mark>ter cut</mark> –off current, gate– emitter short– <mark>circuite</mark> d	V _{GE} = 0 V, V _{CE} = 1200 V V _{GE} = 0 V, V _{CE} = 1200 V, T _J = 175°C	ICES	_	_ 2.5	0.4 -	mA
Gate leakage current, collector-emitter short-circuited	V _{GE} = 20 V , V _{CE} = 0 V	IGES	-	-	200	nA
Input capacitance		C _{ies}	-	4420	-	pF
Output capacitance	$V_{CE} = 20 \text{ V}, \text{ V}_{GE} = 0 \text{ V}, \text{ f} = 1 \text{ MHz}$	C _{oes}	_	151	-	
Reverse transfer capacitance		Cres	-	81	-	
Gate charge total		Qg	-	178	-	nC
Gate to emitter charge	V_{CE} = 600 V, I _C = 25 A, V _{GE} = 15 V	Q _{ge}	-	39	-	
Gate to collector charge		Q _{gc}	-	83	-	
SWITCHING CHARACTERISTIC, INDUC	TIVE LOAD					
Turn-on delay time		t _{d(on)}	_	87	-	ns
Rise time		tr	-	28	-	
Turn-off delay time	T _J = 25°C	t _{d(off)}	—	179	-	
Fall time	$V_{CC} = 600 \text{ V}, \text{ I}_{C} = 25 \text{ A}$ $R_{g} = 10 \Omega$	t _f	-	136	-	
Turn-on switching loss	$V_{GE} = 0 V/15V$	Eon	-	1.95	-	mJ
Turn-off switching loss		E _{off}	-	0.60	-	
Total switching loss		E _{ts}	-	2.55		
Turn–on delay <mark>time</mark>		t _{d(on)}	-	84	-	ns
Rise time		tr	-	29	_	
Turn–off delay time	T _J = 150°C V _{CC} = <mark>600 V, I_C = 25 A</mark>	t _{d(off)}	2-0	185	-	
Fall time	$V_{CC} = \frac{600}{R_{g}} V, I_{C} = 25 A$ $R_{g} = 10 \Omega$	t _f		245	<u> </u>	
Turn–on switching loss	$V_{GE} = 0 V/15V$	E _{on}	-	2.39	-	mJ
Turn–off switching loss	1 F	E _{off}	_	1.26	-	
Total switching loss	1	E _{ts}	_	3.65	-	
DIODE CHARACTERISTIC						
Forward voltage	$V_{05} = 0 V_{15} = 25 A_{15}$	Vr		2 10	2.60	V

Forward voltage	V _{GE} = 0 V, I _F = 25 A V _{GE} = 0 V, I _F = 50 A, T _J = 175°C	V _F		2.10 2.30	2.60 -	V
Reverse recovery time	$T_{J} = 25^{\circ}C$	t _{rr}	-	154	-	ns
Reverse recovery charge	I _F = 25 A, V _R = 400 V di _F /dt = 200 A/μs	Q _{rr}	_	1.3	-	μC
Reverse recovery current		I _{rrm}	-	15	-	А

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

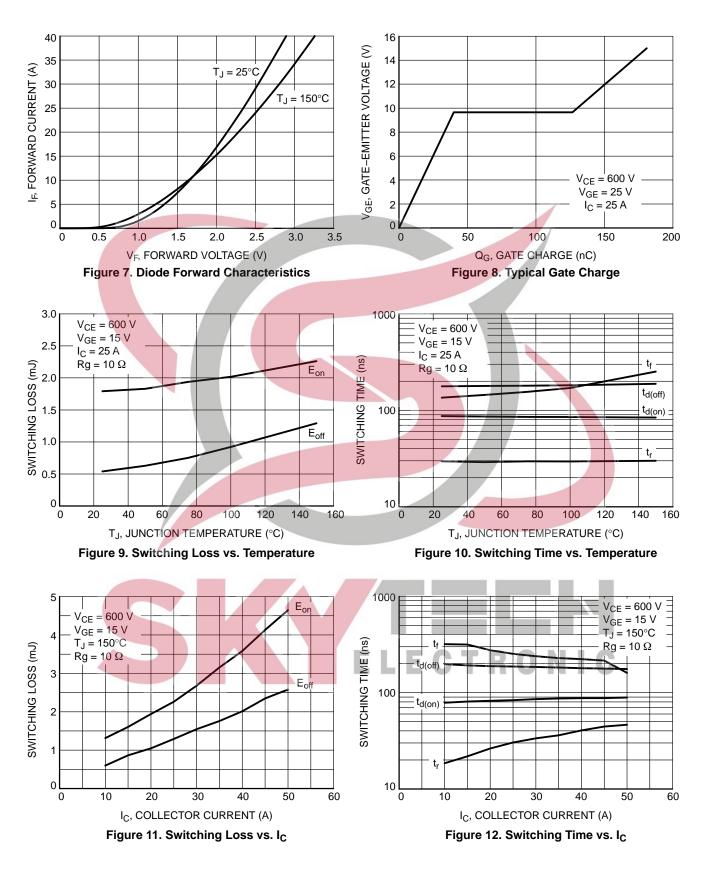
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TYPICAL CHARACTERISTICS



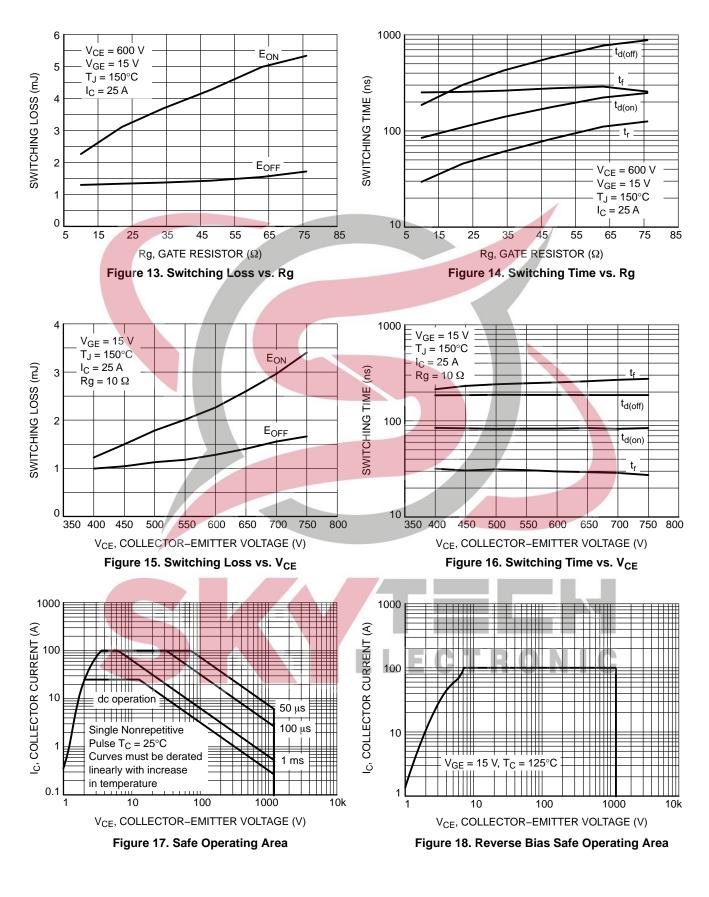
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TYPICAL CHARACTERISTICS

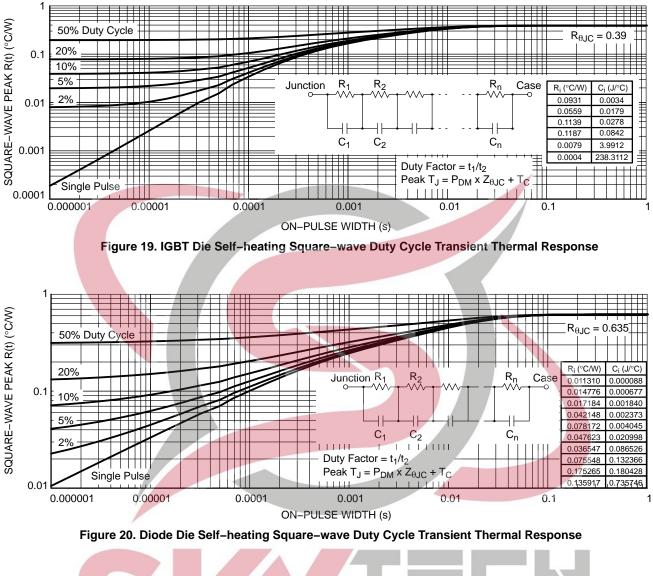


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TYPICAL CHARACTERISTICS

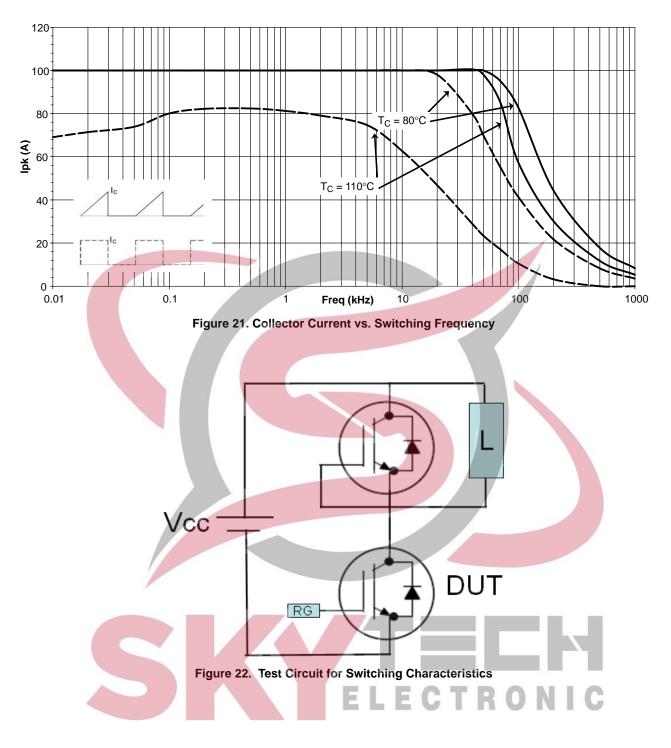


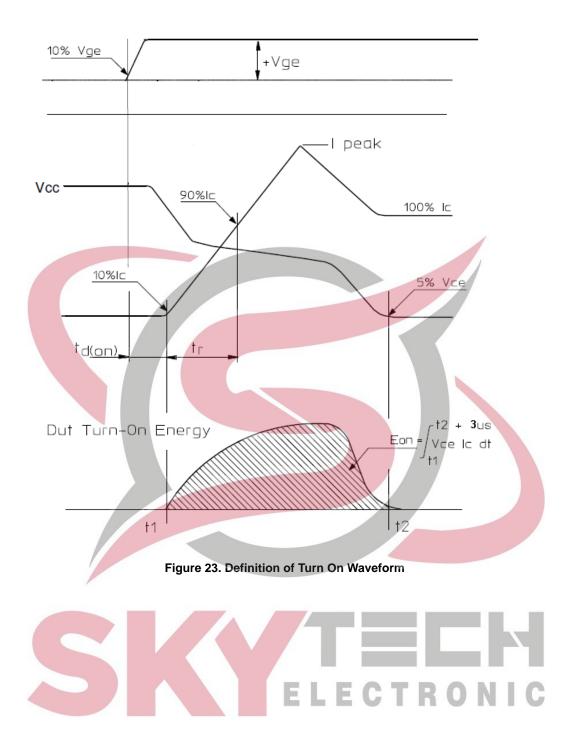
TYPICAL CHARACTERISTICS

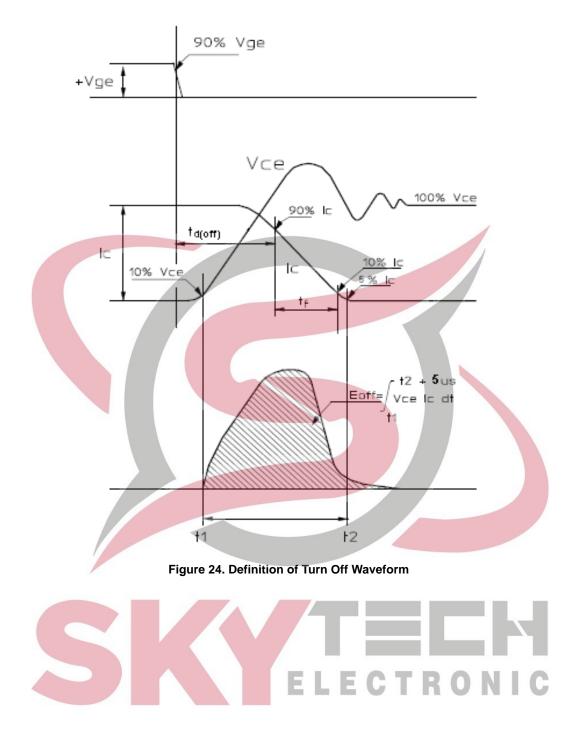




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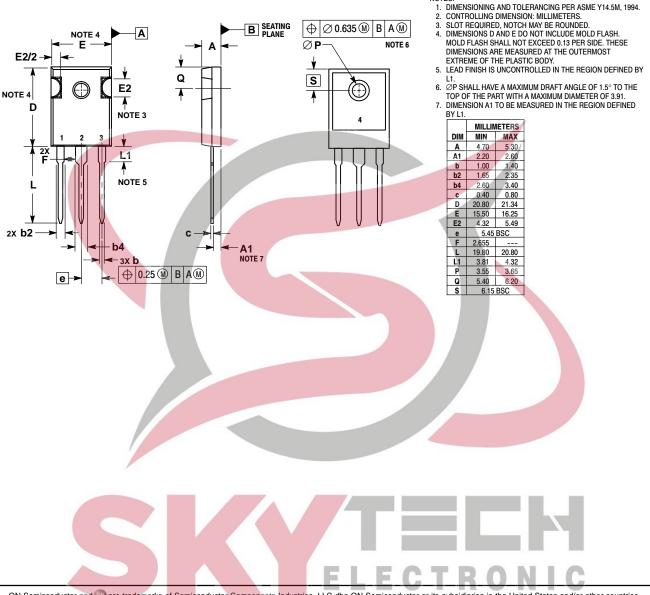




PACKAGE DIMENSIONS

TO-247 CASE 340AL ISSUE C

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